

I2C Sub SYS		Function	Part Number	I2C Spec.	i2C Slave Address / Write / Read (7-bit mode)			
100.0	A.D.	Cap Touch controller	GT1151	400 Kbps	0x5D	Write:0xBA / Read:0xBB		
I2C-0	AP							
		Magnetic Sensor	AK09918C	400 Kbps	0x0C	Write:0x18 / Read:0x19		
I2C-1 (I3C)	AP	Ambient Light Sensor Proximity Sensor	CM36558	400 Kbps	0x51	Write:0xA2 / Read:0xA3		
()	Sensor Hub	Pressure Sensor	BMP280	400 Kbps	0x77	Write:0xEE / Read:0xEF		
I2C-2	AP	Rear Camera	IMX230 EEPROM AF driver	400 Kbps 400 Kbps 400 Kbps	0x1A 0x50 0x0C	Write:0x34 / Read:0x35 Write:0xA0 / Read:0xA1 Write:0x18 / Read:0x19		
(I3C)								
I2C-3	AP	Audio Smart PA	RT5510	400 Kbps	0x34	Write:0x68 / Read:0x69		
		NFC	ST21NFCD	400 Kbps	0x08	Write:0x10 / Read:0x11		
I2C-4 (I3C)	AP	Front Camera	S5K2T7 EEPROM AF driver=NA	400 Kbps 400 Kbps	0x2D 0x52	Write:0x5A / Read:0x5B Write:0xA4 / Read:0xA5		
I2C-5	AP	Sub-PMIC	MT6371 PMU MT6371 PD	3.4 Mbps 3.4 Mbps	0x34 0x4E	Write:0x68 / Read:0x69 Write:0x9C / Read:0x9D		
I2C-6	AP							

Note: I2C Spec.: Standard mode (100 kbps) and Fast mode (400 kbps), Fast mode Plus (1 Mbps) and High-speed mode (3.4 Mbps)

华勤	通讯 Huaqin Telecom Te	echnolog	ιλ	Com	.,Ltd
Title	02_I2C_ID_Overview				
Size C	Project AL1830_MB_	_V1			Rev v1
Date:	Friday, December 28, 2018	Sheet 2	2	of	35

华勤	通讯 Huaqin Telecom Technology Com.,	Ltd
Title	03_Change_Notice	
Size C	Project AL1830_MB_V1	Rev v1
Date:	Friday, December 28, 2018 Sheet 3 of 3	35

- 1, BQ25601电路优化
- 2, ADD USB 电压侦测电路
- 3, WS3218 兼容设计优化 去掉4颗 TVS
- 4, 增加CONFIGO/1测试点 换D2200物料
- 5, 更正 U5101 WIFI/GPS合路器

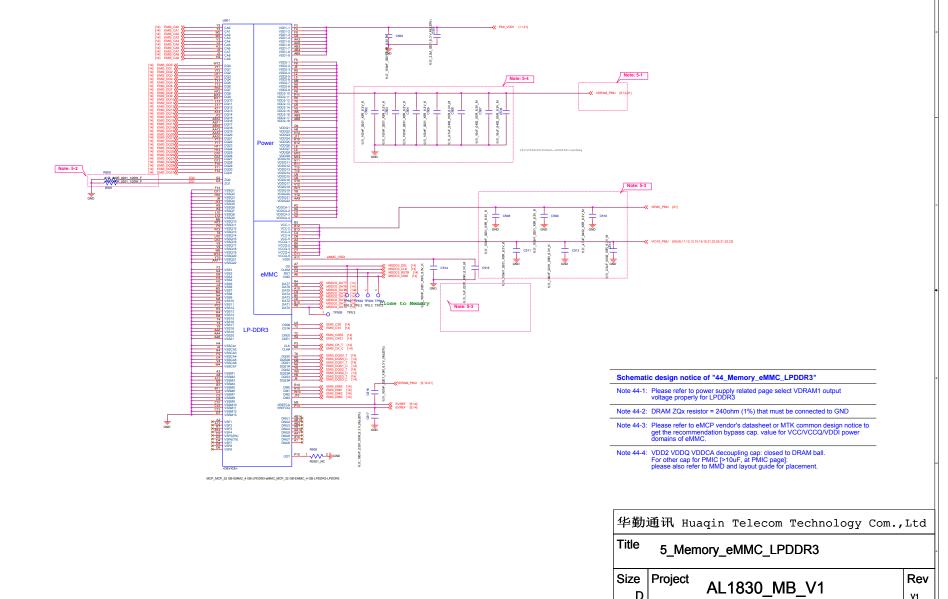
08.24: 1. J7506更换库为HQ11910421000 2.

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Title 04_CHANGELIST

Size Project AL1830_MB_V1 Rev
v1

Date: Friday, December 28, 2018 Sheet 04 of 35



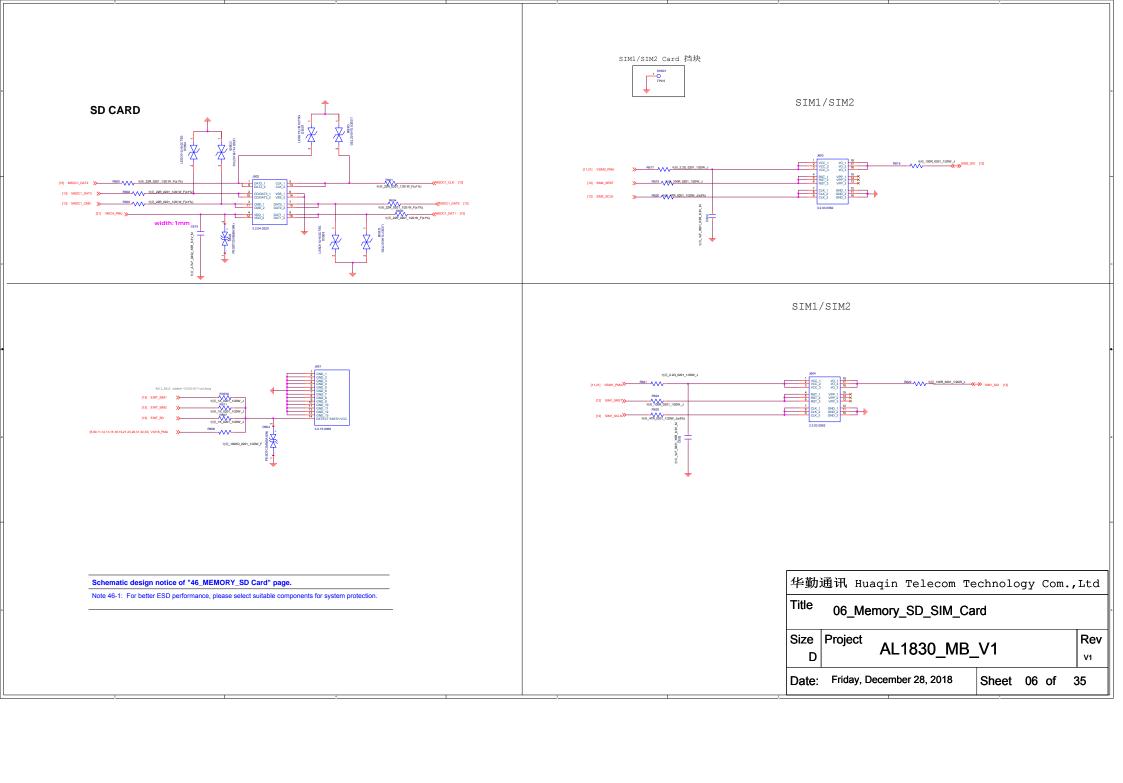
D

Date: Friday, December 28, 2018

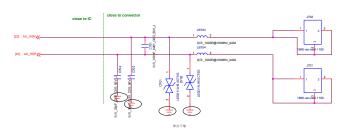
V1

35

Sheet 5 of

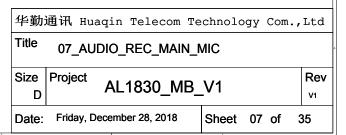


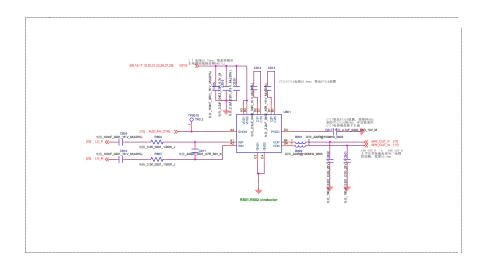
Receiver



Main MIC (6.6), 1/4, 0001, 2041, 2017, M (6.6), 1/4, 0001, 2041, A.3 1/4, M (6.6), 1/4, 0001, A.3 1/4, M (6.6), 1/4, 1/4, M (6.6), 1/4, 1/4, M (6.6), 1/4, 1/4, M (6.6), 1

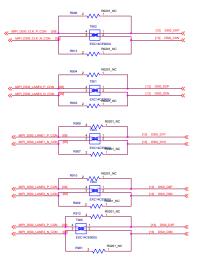
R701,R703->1uF for ACC mode





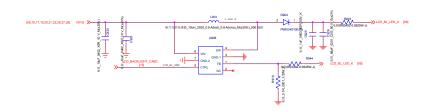
华勤通讯 Huaqin Telecom Technology Cor	m.,Ltd						
Title 08_AUDIO_SPEAKER_AMP							
Size Project AL1830_MB_V1	Rev v1						
Date: Friday, December 28, 2018 Sheet 08 of	35						

LCD MIPI Common Mode Filter



First using OR , Second using EMI Filter.

LCD-BACKLIGHT

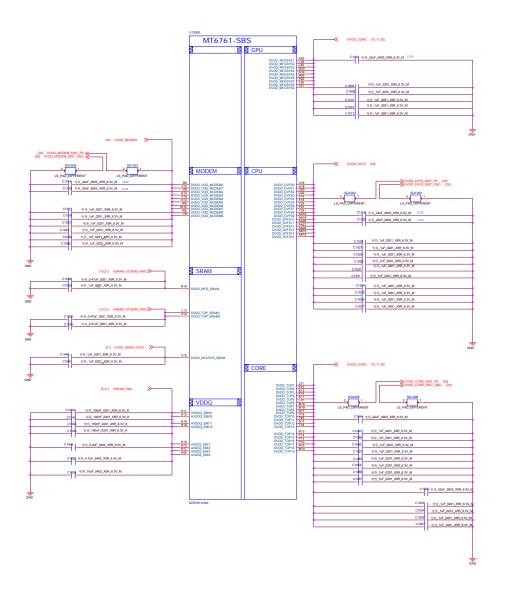


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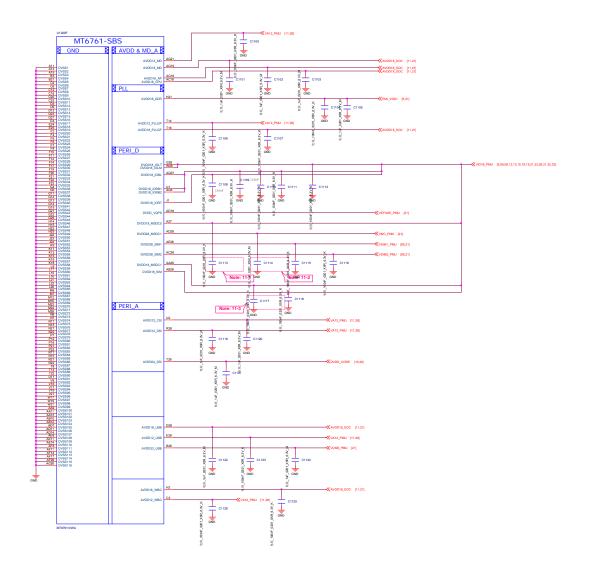
Title 09_LCD_CTP_BL

Size Project AL1830_MB_V1 Rev v1

Date: Friday, December 28, 2018 Sheet 09 of 35



华勤:	通讯 Huaqin	Telecom	Technolo	gy Com	.,Ltd
Title	10_MT6762	_BB_POW	ER_PDN		
Size D	Project AL	1830_MI	B_V1		Rev v1
Date:	Friday, Decemb	er 28, 2018	Sheet	10 of	35



Schematic design notice of "11_BB_POWER_IO" page.

Note 11-1: C4101 closed DVDD18_MSDC0 150mil

Note 11-2: C4302 closed DVDD28_MSDC1 150mil

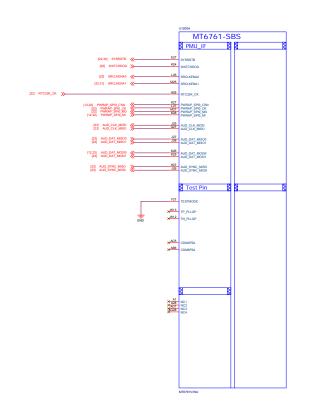
Note 11-3: C4301 closed DVDD18_MSDC1 150mil

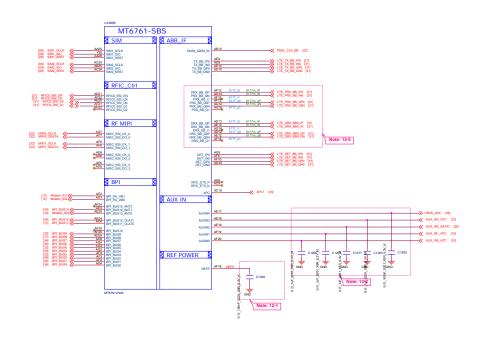
华勤通讯 Huaqin Telecom Technology Com., Ltd

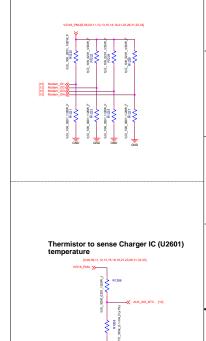
Title 11_MT6762_BB_POWER_IO

Size Project AL1830_MB_V1 Rev

Date: Friday, December 28, 2018 | Sheet 11 of









Note 12-1: The de-coupling cap. for REFP (AF18 ball) have to be placed as close to BB as possible.

Note 12-2: To shunt a 1uF capacitor in the AUXIN ADC input to prevent noise coupling. It should be placed as close to BB as possible. Connect the unused AUX ADC input to GND.

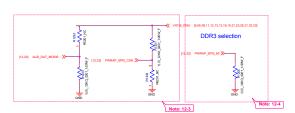
Note 12-3: "PWRAP_SPI0_CSN" and "AUD_DAT_MOSI0" are bootstrap pin to select which interface will be the JTAG pin out.

PWRAP_SPI0_CSN	AUD_DAT_MOSI0	JTAG Function			
default=PU	default=PD	AP_JTAG	MD_JTAG		
HI	LO	N/A	N/A		
HI	H (by ext. PU)	SPI0+EINT8	SPI1+SPI3		
LO (by set. PD)	LO	SPI0+EINT8	N/A		
LO (by ext. PD)	H (by ext. PU)	MSDC1	N/A		

Note 12-4: PWRAP_SPI0_MO and PWRAP_SPI0_MI are DDR type feature in bootstrap

PWRAP_SPI0_MI	Booting interfa	ice		
default=PU	DDR	MSDC0 pin mux		
LO (by ext. PD)	LPDDR3	follow LP3 Ref SCH.		
H	LPDDR4X	follow LP4X Ref SCH.		

Note 12-5: Please set unused IQ pins in NC

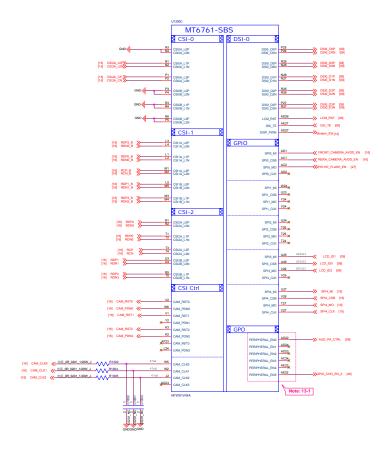


华勤通讯 Huaqin Telecom Technology Com., Ltd

Title 12_MT6762_BB_1

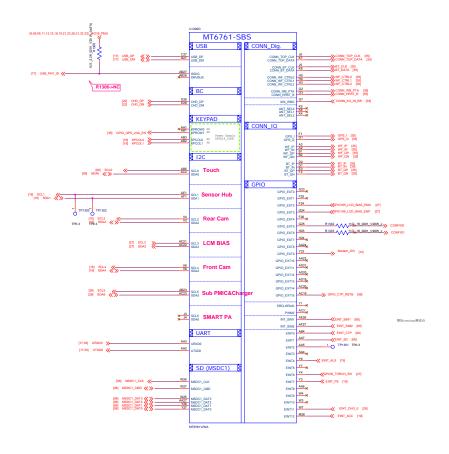
Size D Project AL1830_MB_V1 Rev

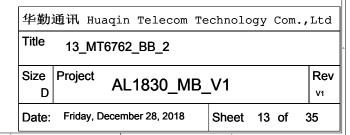
Date: Friday, December 28, 2018 | Sheet 12 of 35

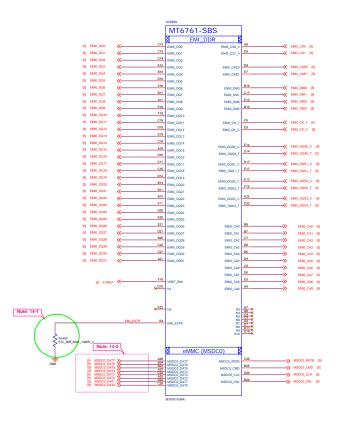


Schematic design notice of "13_BB_2" page.

Note 13.1: The enable pin of acoustic or optoelectronic devices (e.g. SPK AMP/Backlight/Charger OCP/OVP) suggest to use Peripheral_EN[0.5] if use other GPIOs as enable pin, suggest to reserve 0201 NC to GND





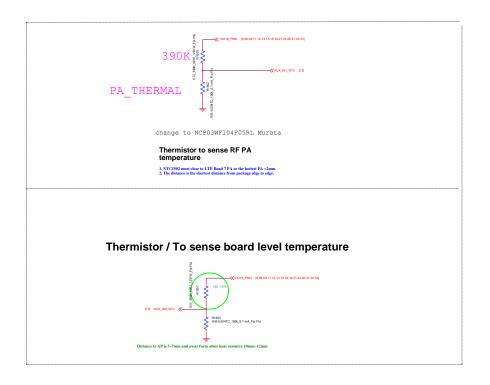


Schematic design notice of "14_BB_3" page.

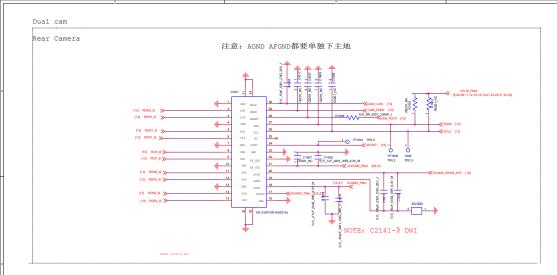
Note 14-1: R4001 please select 34.8 ohm (1%) resistor

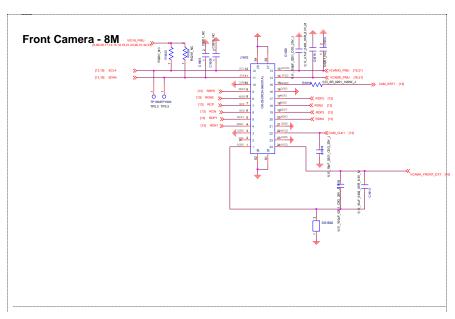
Note 14-2: Please check eMCP LP3 and eMCP LP4X pin mux

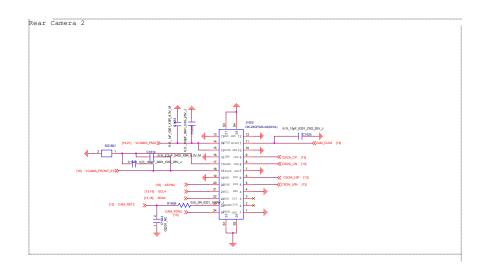
华勤:	通讯	Huaqin	Telecom	Те	chnolc	gy	Com.	,Lt	d
Title	14_	_MT6762	_BB_3						
Size D	Proje	ect AL	1830_M	B_	V1			Re v1	:V
Date:	Frida	ay, Decemb	er 28, 2018		Sheet	14	of	35	

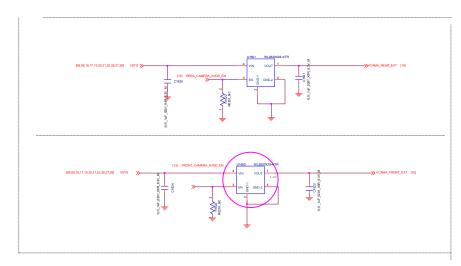


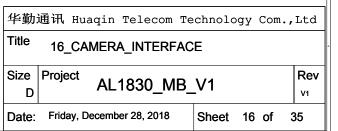
华勤通讯 Huaqin Telecom Technology Com.,Ltd								
Title 15_BB_AUXADC_Thermal								
Size D	Project AL1830_MB_	_V1 Rev						
Date:	Friday, December 28, 2018	Sheet 15 of 35						

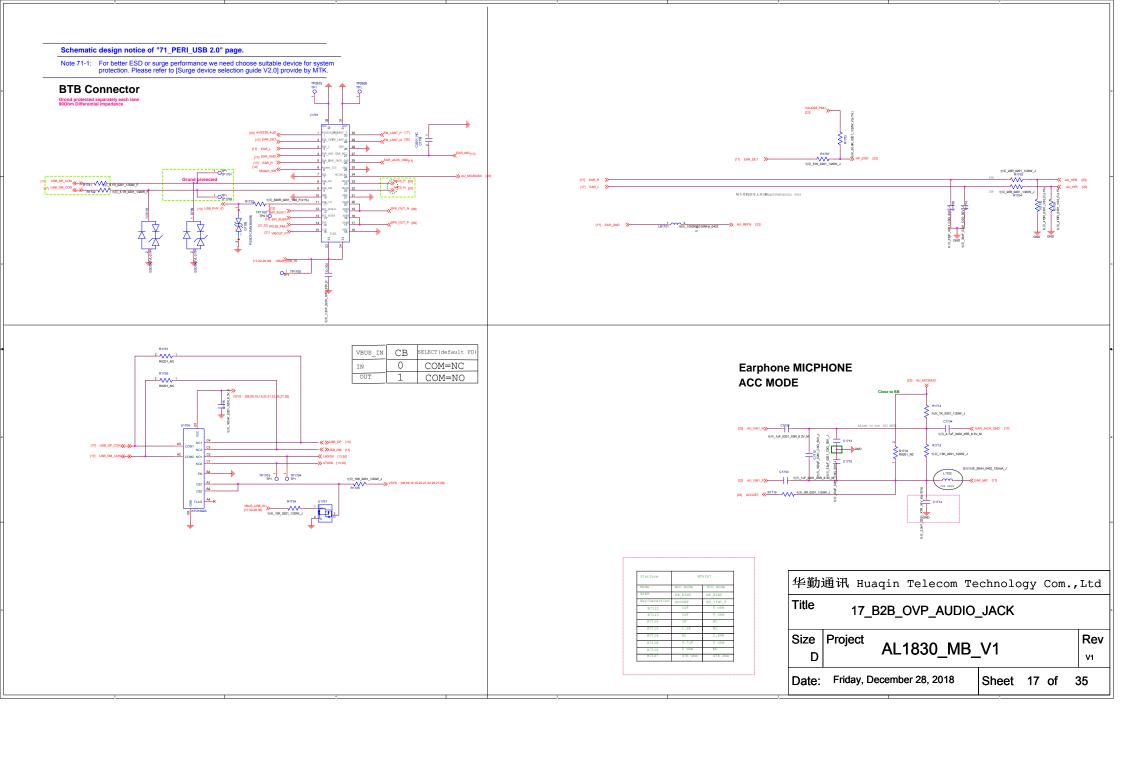


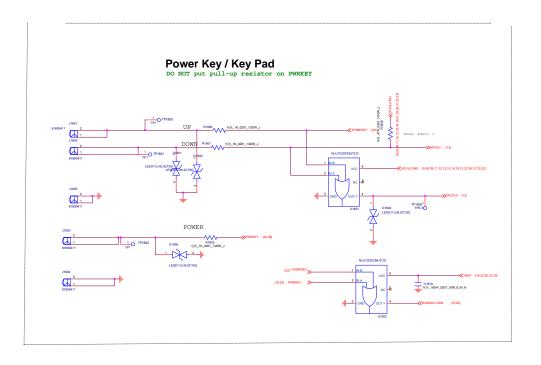












Schematic design notice of "65_PERI_Dual_SIM_ICUSB_KEYPAD" page. Note 75-1: DO NOT put pull-up resistor on PWRKEY

Note 75-2: Volume Up : HOME Key / GND Volume Down : KPROW0/KPCOL0

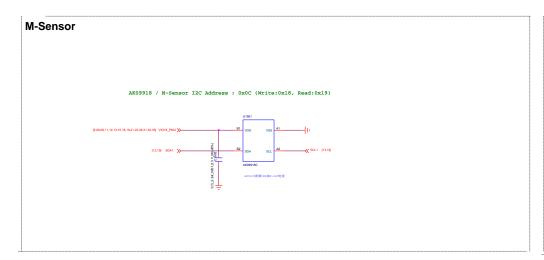
Note 75-3: For better ESD performance, please select suitable components for system protection.

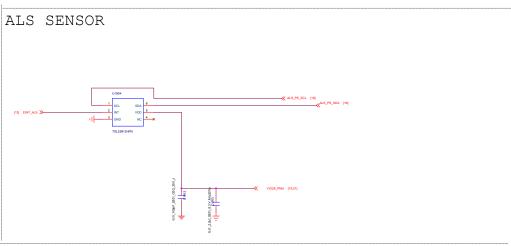
华勤通讯 Huaqin Telecom Technology Com., Ltd

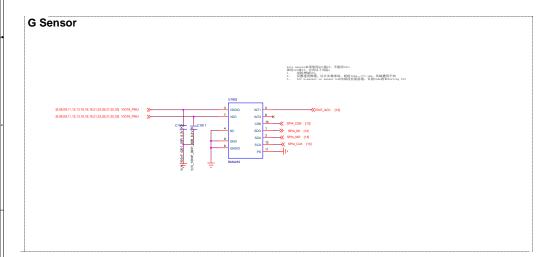
Title 18_KEYPAD_INTERFACE

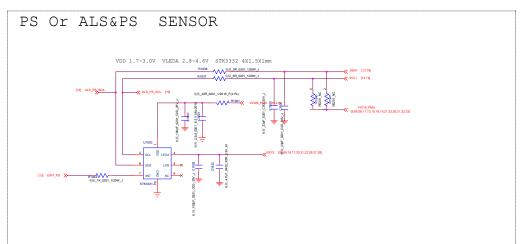
Size Project AL1830_MB_V1 Rev
v1

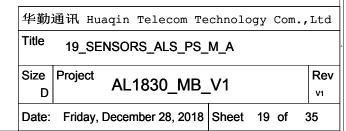
Date: Friday, December 28, 2018 Sheet 18 of 35

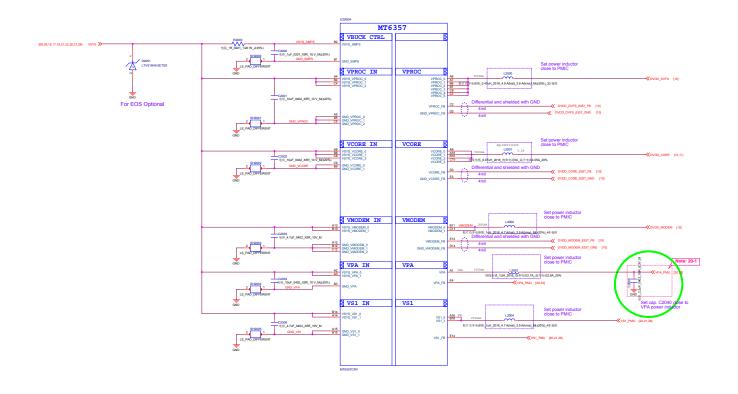










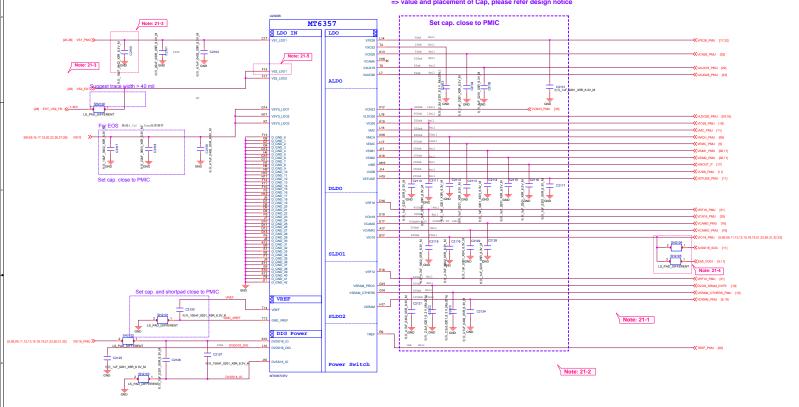


Schematic design notice of "20_POWER_MT6357_Buck"

Note 20-1: C2040, please choose 0603 size

华勤:	通讯 Hu	aqin	Telecom	Те	chnolo	дУ	Com.	,Ltd
Title	20_PO	WER	_MT6357_	Bu	ck			
Size D	Project	AL	1830_M	B_	_V1			Rev v1
Date:	Friday,	Decen	nber 28, 20	18	Sheet	20	of	35

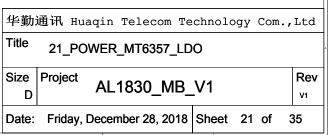


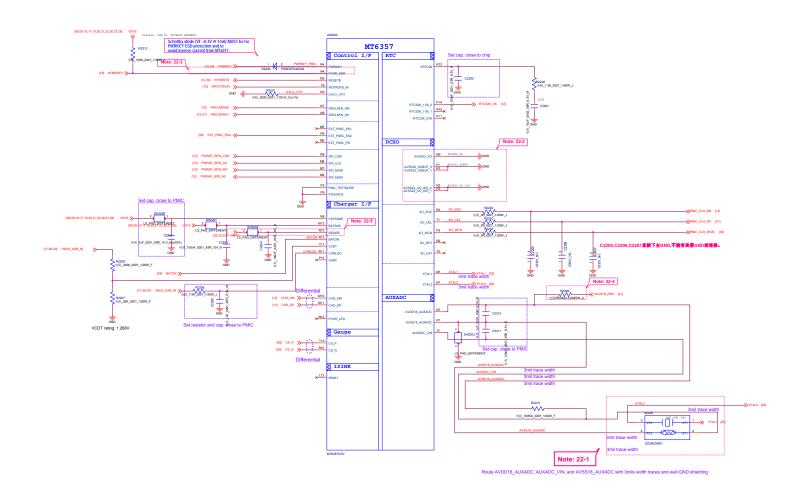


Schemati	c design notice o	of "21_PO	WER_MT6357_	LDO"		
Note 21-1: If these power trace can meet LDO layout constraint, these CAP can be NC or removed Please refer to MT6357 design notice.					removed	
Note 21-2:	e 21-2: Output cap range please follow MT6357CRV LDO design notice					Note 21-4: Please set SH2101 and SH2102 close to C2141, making star connection among VIO18_PMU, AVDD18_SOC, and EMI VDD1 near to LDO cap. C2141
Note 21-3:	Note 21-3: Ext Buck BOM option w/ EXT \		Ext. buck w/ EXT VS2 Buck	w/o EXT VS2 Buck		Please also refer to MT6357 design notice for further detail design information
		C2104 R2851	10uF 0-ohm , 0603	22uF NC	l	Note 21-5: Please connect VS2_LDO1(F15) to VS1_PMU if voltage applied to VCAMD(E17) >= 1.3 V
		R2852	NC	0-ohm, 0603		

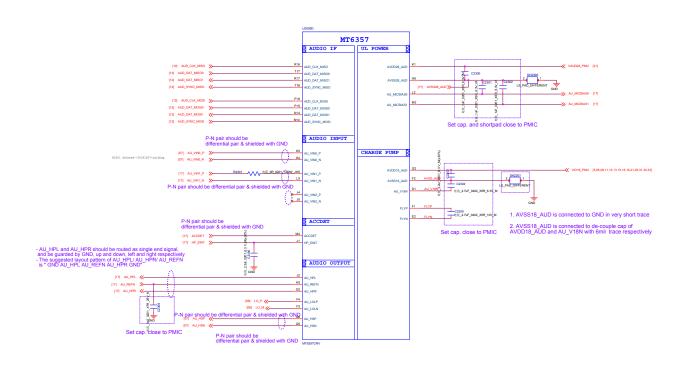
MT6356 LDO output

Input Power	Power Name	Output Voltage (V)	Output Current	Default Voltage
	VFE28	2.8	40mA	2.8V
	VXO22	2.24	25mA	2.24V
	VCN28	2.8	40mA	2.8V
	VCAMA	1.8/2.5/2.8	200mA	2.8V
	VAUX18	1.8	20mA	1.8V
	VAUD28	2.8	50mA	2.8V
	VBIF28	2.8	1mA	2.8V
LDO from	VCN33	3.3/3.4/3.5/3.6	800mA	3.3V
VBAT	VLD028	2.8/3.0	360mA	2.8V
	VIO28	2.8	200mA	2.8V
	VMC	1.86/2.9/3.0/3.3	200mA	3.0V
	VMCH	2.9/3.0/3.3	800mA	3.0V
	VEMC	2.9/3.0/3.3	800mA	3.3V
	VSIM1	1.7/1.8/1.86/2.76/3.0/3.1	200mA	1.86V
	VSIM2	1.7/1.8/1.86/2.76/3.0/3.1	200mA	1.86V
	VIBR	1.2/1.3/1.5/1.8/2.0/2.8/3	.0/3.3 200mA	2.8V
	VUSB	3.07	50mA	3.07V
	VRF18	1.81	450mA	1.81V
	VMIPI	1.71/1.8/1.84	300mA	1.84V
LDO from VS1	VCN18	1.8	200mA	1.8V
****	VCAMD	1/1.05/1.1/1.2/1.3/1.5/1.	8 600mA	1.2V
	VCAMIO	1.8	300mA	1.8V
	VIO18	1.8	1200mA	1.8V
	VRF12	1.2	200mA	1.2V
	VA12	1.2	300mA	1.2V
LDO from VS2	VSRAM_PROC	0.6-1.31	400mA	1.1V
***	VSRAM_OTHER	RS 0.6-1.31	200mA	0.97
	VSRAM_GPU	0.6-1.31	400mA	1.0V
	VDRAM	1.12/1.24	1000mA	1.24v





		华勤通讯 Huaqin Telecom Technology Com.,Ltd			
Schematic design notice of "22_POWER_MT6357-IF"		Title 22 POWER MT6357 IF			
Note 22-1: Please implement 2520 & 2016 Size TMS PCB co-layout. Please refer to MT6765_MT6357 Co-Clock Design Notice for co-layout guide			22 07721(10007		
Note 22-2: 1. Please Connect P1 and R1 ball first and then to GND 2. Please Connect P2 and N2 ball first and then to GND 3. Please connect D2 connect P2 ball first and then to GND 0. D1 connect through L1 GND 0. NOT connect through L1 GND 0. NO		Size Project AL1830_MB_V1 Rev			
Note 22-3: Let floating if disable HOMEKEY function		U			VI
Note 22-4: Please follow MT6765_MT6357 Co-Clock Design Notice for Layout guide of VAUX18, then R8101_can use 0 ohm to replace BEAD.	Note 22-5: Please connect to battery connector	Date:	Friday, December 28, 2018	Sheet 22 of	35
				1	

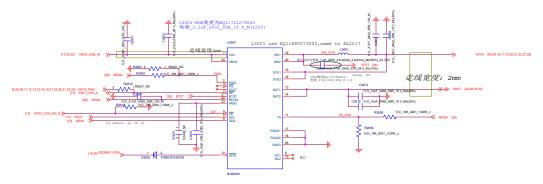


华勤通讯 Huaqin Telecom Technology Com.,Ltd						
Title 23_POWER_MT6357_Audio						
Size Project AL1830_MB_V1						
Date: Friday, December 28,	2018 Sheet 23 of 35					





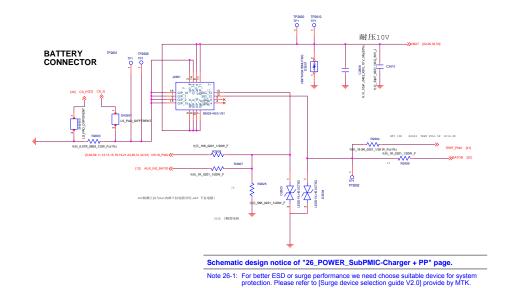
BQ25601 Charger



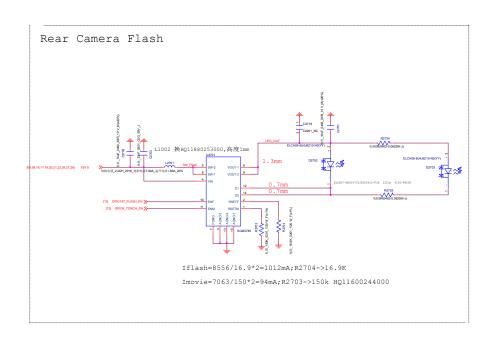
BQ25601 I2C address:0x6BH

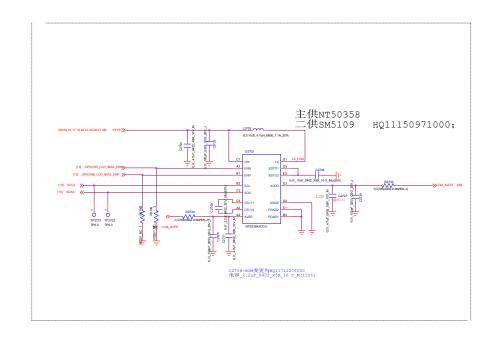
Notel:PREL pin, Power source selection input. Set 500 mk input current limit by pulling this pin high and set 2.4A input current limit by pulling this pin low. Once the device gets into host mode, the host can program different input current limits to IINDPM register





华勤通讯 Huaqin Telecom Technology Com.,Ltd						
Title 26_Charger_IC_BQ25601+BATTERY						
Size D	Size Project AL1830_MB_V1					
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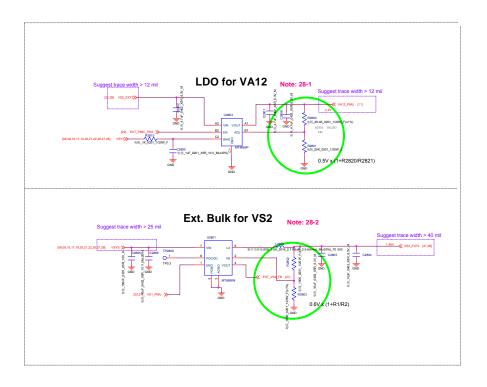
Schematic design notice of "27_POWER_SubPMIC-HV powers" page:

Note 27-1: To minimize RF de-sense, it is recommended to reserve 0-ohm and 0402 cap for BOM fine tuning.

Note 27-2: To minimize RF de-sense, it is recommended to reserve 0-ohm and 0201 cap. for BOM fine tuning.

Note 27-3: C2705 could be replaced with C / 1 / uF / 50V + C / 1 / uF / 50V





Schematic design notice of "28_POWER_ThirdParty-Power"

Note 28-1: VA12 Layout placement please close to AP

Note 28-2: VS2 Buck Layout placement please close to PMIC MT6357

Note 28-3: VCN33 LDO Layout placement please close to MT6631

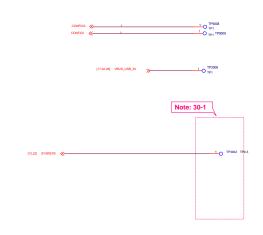
华勤通讯 Huaqin Telecom Technology Com., Ltd

Title 28_POWER_ThirdParty_Powers

Size D Project AL1830_MB_V1 Rev V1

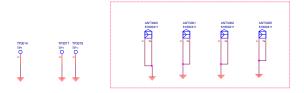
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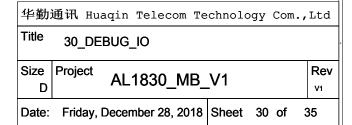


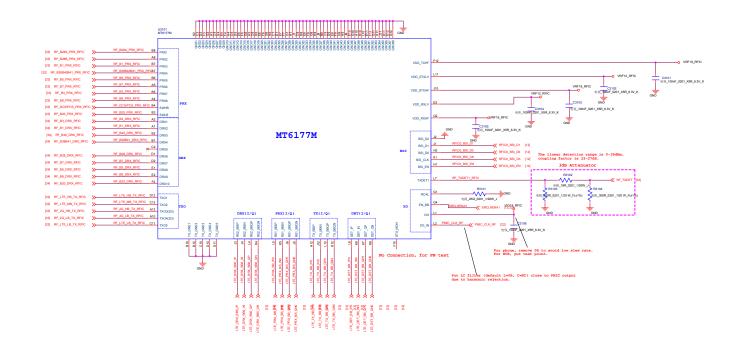


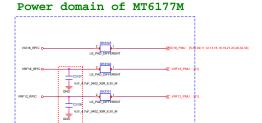
Rear Camera TO GND











华勤通讯 Huaqin Telecom Technology Com.,Ltd								
Title 31_RF_MT6177_Pin_Out								
Size D	Project AL1810_MB_V1	Re v1						
Date:	Friday, December 28, 2018 Sheet 31	of 35						

